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CLIENT NO.: STMI01-01055
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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Harry Michael Siegel et al.
Application No. : 10/062,595
Filed : January 31, 2002
For : SYSTEM AND METHOD FOR ALIGNING AN INTEGRATED
CIRCUIT DIE ON AN INTEGRATED CIRCUIT SUBSTRATE
Group No. : 3725
Examiner : David B. Jones

MAIL STOP ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT UNDER 37 C.F.R. § 1.312

Pursuant to 37 C.F.R. § 1.312, please amend the above-identified application as follows: